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ISD3800

Digital ChipCorder

with

Digital Audio Interface

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1 GENERAL DESCRIPTION

The ISD3800 is a digital ChipCorder® featuring digital compression, comprehensive memory management, and integrated analog/digital audio signal paths. The ISD3800 utilizes serial flash memory to provide non-volatile audio playback for a two-chip solution. The ISD3800 provides an I²S digital audio interface, faster digital programming, higher sampling frequency, and a signal path with SNR 80dB.

The ISD3800 can take digital audio data via I²S or SPI interface. When I²S input is selected, it will replace the analog audio inputs and will support sample rates of 32, 44.1 or 48 kHz depending upon clock configuration. When SPI interface is chosen, the sample rate of the audio data sent must be one of the ISD3800 supported sample rates.

The ISD3800 has inbuilt analog audio inputs, analog audio line driver, and speaker driver output.

The analog audio input, Aux-in, has a fixed gain configured by SPI command. Aux-in can directly feed-through to the analog outputs; it can also mix with the DAC output and then feed-through to the analog outputs.

Analog outputs are available in two forms: (1) Aux-out is an analog single-ended voltage output; (2) Class-AB BTL (bridge-tied-load) is an analog differential voltage output. Class-AB BTL delivers 1-watt output power at V_{CCSPK} = 5V.

Class-D PWM direct-drive is also available, which delivers 1-watt output power at V_{CCSPK} = 5V.

2 FEATURES

- External Memory:
  - The ISD3800 supports the following flash:

Manufacturer	Winbond		Numonyx			MXIC
Family	25X	25Q	25P	25PX	25PE	25L / 25V
JEDEC ID	EF 30 1X	EF 40 1X	20 20 1X	20 71 1X	20 80 1X	C2 20 1X

  - The addressing ability of ISD3800 is up to 128Mbit, which is 64-minute playback time based on 8kHz/4bit ADPCM.
  - Inbuilt 3V voltage regulator to provide power source to the external flash memory
- Fast Digital Programming
  - Programming rate can go up to 1Mbits/second mainly limited by the flash memory write rate.
- Memory Management
  - Store pre-recorded audio (Voice Prompts) using high quality digital compression
  - Use a simple index-based command for playback
  - Execute pre-programmed macro scripts (Voice Macros) designed to control the configuration of the device and play back Voice Prompts sequences.
- Sample Rate
  - Seven sampling frequencies are available for a given master sample rate. For example, the sampling frequencies of 4, 5.3, 6.4, 8, 12.8, 16 and 32kHz are available when the device is clocked at a 32kHz master sample rate.
  - For I²S operation, 32, 44.1 and 48kHz master sample rates are available with playback sampling frequencies scaling accordingly.
- Compression Algorithms
  - For Pre-Recorded Voice Prompts
    - μ-Law: 6, 7 or 8 bits per sample

- Differential μ-Law: 6, 7 or 8 bits per sample
- PCM: 8, 10 or 12 bits per sample
- Enhanced ADPCM: 2, 3, 4 or 5 bits per sample
- Variable-bit-rate optimized compression. This allows best possible compression given a metric of SNR and background noise levels.

- Oscillator
  - Internal oscillator with internal reference: 2.048 MHz with ±1% deviation
  - Internal oscillator with external resistor: 2.048 MHz with ±2% deviation[1]
  - External crystal or clock input
    - Crystals support standard audio sampling rates of 2.048, 4.096, 8.192, 12.288 and 11.2896MHz
  - I^2S bit clock input
- Inputs
  - Aux-in: Analog input with 2-bit gain control configured by SPI command
- Outputs
  - PWM: Class-D speaker driver to directly drive an 8Ω speaker or buzzer
    - Deliver 1-watt output power at V_{CCSPK} = 5V
  - Aux-out: an analog single-ended voltage output
  - Class-AB BTL: an analog differential voltage output
    - Deliver 1-watt output power at V_{CCSPK} = 5V
    - Class-AB BTL can directly drive an 8Ω speaker or buzzer
    - Class-AB BTL can drive an 8Ω speaker or buzzer via an external amplifier
- I/Os
  - SPI interface: MISO, MOSI, SCLK, SSB for commands and digital audio data
  - I^2S interface: I^2S_CLK, I^2S_WS, I^2S_SDI, I^2S_SDO for digital audio data
  - 8 GPIO pins:
    - 4 GPIO pins share with I^2S
    - 4 GPIO pins share with SPI Interface
    - GPIO pins can trigger Voice Macro for a pushbutton application
- 8-bit Volume Control set by SPI command for flexible mixing
- Operating Voltage: 2.7 ~ 5.5V
- Standby Current: 1uA typical
- Package:
  - Green 48L-LQFP
- Temperature Options:
  - Industrial: -40°C to 85°C

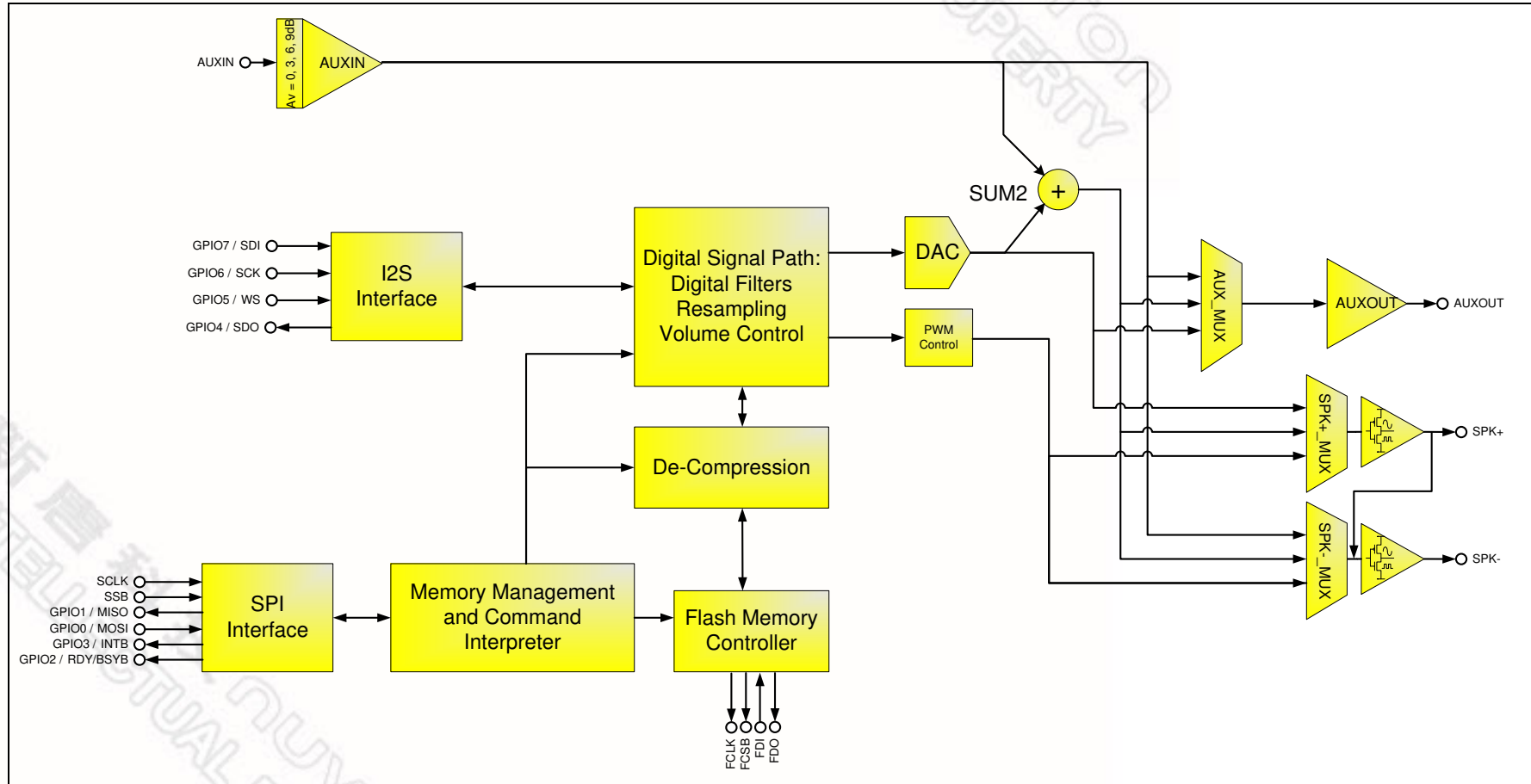[1] With ±1% precision 80kohm external resistor.

3 BLOCK DIAGRAM

Figure 3-1 ISD3800 Block Diagram
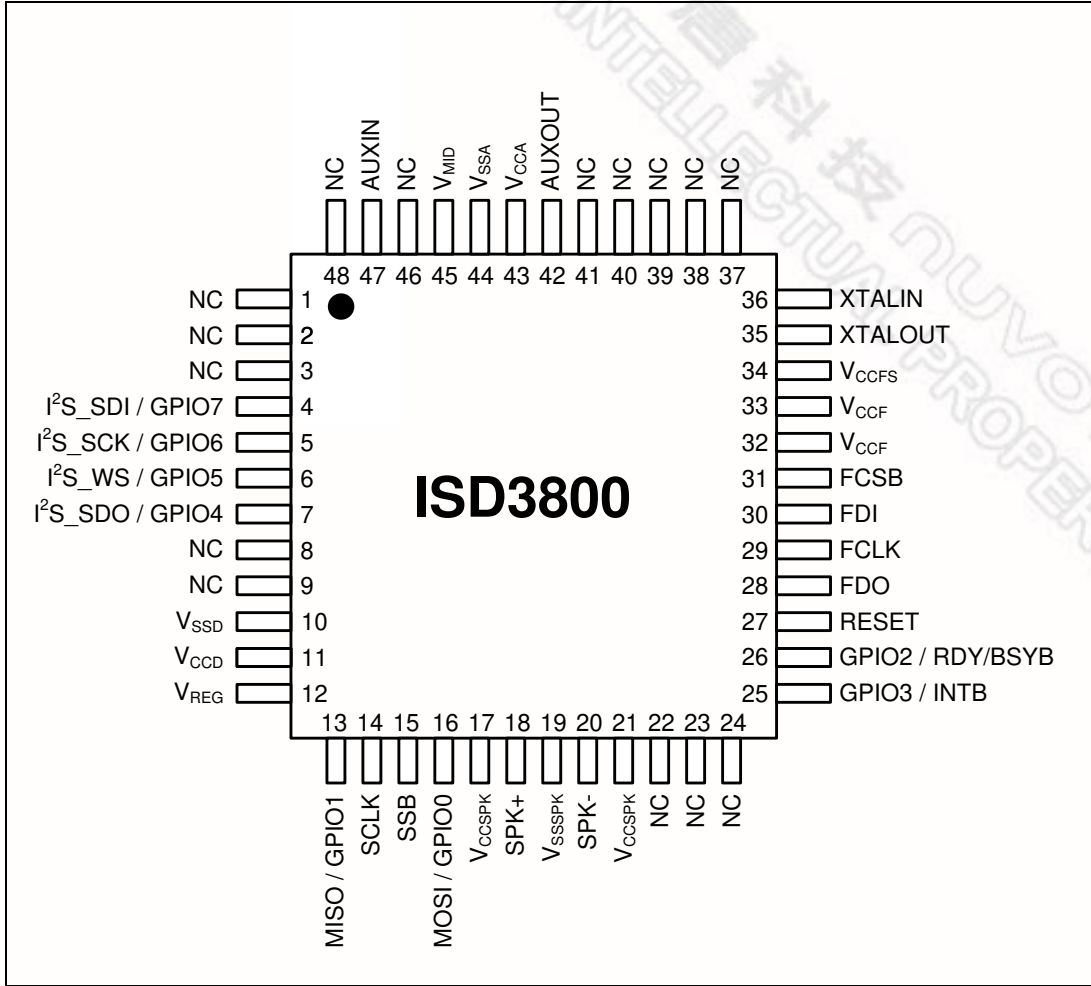
4   PINOUT CONFIGURATION

4.1   48L-LQFP

Figure 4-1 ISD3800 48-Lead LQFP Pin Configuration.

5 PIN DESCRIPTION

Pin Number 48L-LQFP	Pin Name	I/O	Function
1	NC		This pin should be left unconnected.
2	NC		This pin should be left unconnected.
3	NC		This pin should be left unconnected.
4	GPIO7 / I^2S_SDI	I/O	A GPIO pin. By default this pin is a pull-high input. Can be configured as Serial Data Input of the I^2S interface.
5	GPIO6 / I^2S_SCK	I/O	A GPIO pin. By default this pin is a pull-high input. Can be configured as Clock input in slave mode or clock output in master mode. This pin can be configured as an external clock buffer if I^2S is not used.
6	GPIO5 / I^2S_WS	I/O	A GPIO pin. By default this pin is a pull-high input. Can be configured as Word Select (WS) input in slave mode or WS output in master mode.
7	GPIO4 / I^2S_SDO	I/O	A GPIO pin. By default this pin is a pull-high input. Can be configured as Serial Data Output of the I^2S Interface.
8	NC		This pin should be left unconnected.
9	NC		This pin should be left unconnected.
10	V_{SSD}	I	Digital Ground.
11	V_{CCD}	I	Digital power supply.
12	V_{REG}	O	A 1.8V regulator to supply the internal logic. A minimum 1uF capacitor with low ESR<0.5OHM should be connected to this pin for supply decoupling and stability.
13	MISO / GPIO1	O	Master-In-Slave-Out. Serial output from the ISD3800 to the host. This pin is in tri-state when SSB=1. Can be configured as GPIO1.
14	SCLK	I	Serial Clock input to the ISD3800 from the host.
15	SSB	I	Slave Select input to the ISD3800 from the host. When SSB is low device is selected and responds to commands on the SPI interface.
16	MOSI / GPIO0	I	Master-Out-Slave-In. Serial input to the ISD3800 from the host. Can be configured as GPIO0.

Pin Number 48L-LQFP	Pin Name	I/O	Function
17	V$_{CCSPK}$	I	In PWM mode: Digital Power for the PWM Driver. Deliver 1-watt output power at V$_{CCSPK}$ = 5V. Or, In Class-AB mode: Analog Power for the Class-AB output. Class-AB BTL delivers 1-watt output power at V$_{CCSPK}$ = 5V.
18	SPK+	O	PWM driver positive output. This SPK+ output, together with SPK- pin, provide a differential output to drive 8Ω speaker or buzzer. During power down this pin is in tri-state. Or, can be configured as Class-AB BTL which, together with SPK- pin, provides a differential voltage output. Or, can be configured as a Class-AB single-ended output.
19	V$_{SSSPK}$	I	In PWM mode: Digital Ground for the PWM Driver. Or, In Class-AB mode: Analog Ground for the Class-AB output.
20	SPK-	O	PWM driver negative output. This SPK- output, together with SPK+ pin, provides a differential output to drive 8Ω speaker or buzzer. During power down this pin is tri-state. Or, can be configured as Class-AB BTL which, together with SPK+ pin, provides a differential voltage output. Or, can be configured as a Class-AB single-ended output.
21	V$_{CCSPK}$	I	In PWM mode: Digital Power for the PWM Driver. Deliver 1-watt output power at V$_{CCSPK}$ = 5V. Or, In Class-AB mode: Analog Power for the Class-AB output. Class-AB BTL delivers 1-watt output power at V$_{CCSPK}$ = 5V.
22	NC		This pin should be left unconnected.
23	NC		This pin should be left unconnected.
24	NC		This pin should be left unconnected.
25	INTB / GPIO3	O	Active low interrupt request pin. This pin is an open-drain output. Can be configured as GPIO3.
26	RDY/BSYB / GPIO2	O	An output pin to report the status of data transfer on the SPI interface. "High" indicates that ISD3800 is ready to accept new SPI commands or data. Can be configured as GPIO2.
27	RESET	I	Applying power to this pin will reset the chip. (A high pulse of 50ms or more will reset the chip.)

Pin Number 48L-LQFP	Pin Name	I/O	Function
28	FDO	O	Serial data output of the external serial flash interface. Connects to data input (DI) of external serial flash.
29	FCLK	O	Serial data CLK of the external serial flash interface.
30	FDI	I	Serial data input to external serial flash interface. Connects to data output (DO) of external flash memory.
31	FCSB	O	Chip Select Bar of the external serial flash interface.
32	V_{CCF}	O	Digital power supply for the external flash memory. A minimum 1uF capacitor with low ESR<0.5OHM should be connected to this pin for supply decoupling and stability. Refer to the application diagram.
33	V_{CCF}	O	Digital power supply for the external flash memory. A minimum 1uF capacitor with low ESR<0.5OHM should be connected to this pin for supply decoupling and stability. Refer to the application diagram.
34	V_{CCFS}	I	Digital power supply for the inbuilt voltage regulator for the external flash memory. A 0.1uF capacitor should be connected to this pin for supply decoupling and stability. Refer to the application diagram.
35	XTALOUT	O	Crystal interface output pin.
36	XTALIN	I	The CLK_CFG register determines one of the following three configurations: (1) A crystal or resonator connected between the XTALOUT and XTALIN pins. (2) A resistor connected to GND as a reference current to the internal oscillator and left the XTALOUT unconnected. (3) An external clock input to the device and left the XTALOUT unconnected.
37	NC		This pin should be left unconnected.
38	NC		This pin should be left unconnected.
39	NC		This pin should be left unconnected.
40	NC		This pin should be left unconnected.
41	NC		This pin should be left unconnected.
42	Aux-out	O	Aux Out. This pin is an analog voltage output. If AUXOUT is not used, this pin should be left unconnected.
43	V_{CCA}	I	Analog power supply pin.
44	V_{SSA}	I	Analog ground pin.
45	V_{MID}	O	Middle voltage reference for the swing of analog/digital audio outputs. A 4.7uF capacitor should be connected to this pin for supply decoupling and stability.
46	NC		This pin should be left unconnected.

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Pin Number 48L-LQFP	Pin Name	I/O	Function
47	Aux-in	I	Auxiliary input with the gain set by SPI command If Aux-in is not used, this pin should be left unconnected.
48	NC		This pin should be left unconnected.

6 ELECTRICAL CHARACTERISTICS

6.1 OPERATING CONDITIONS

OPERATING CONDITIONS (INDUSTRIAL PACKAGED PARTS)

CONDITIONS	VALUES
Operating temperature range (Case temperature)	-40°C to +85°C
Digital Supply voltage (V_{CCD}) [1]	+2.7V to +5.5V
Digital Ground voltage (V_{SSD}) [2]	0V
Analog Supply voltage (V_{CCA}) [3]	+2.7V to +5.5V
Analog Ground voltage (V_{SSA}) [2]	0V
Speaker Supply voltage (V_{CCSPK}) [3]	+2.7V to +5.5V
Speaker Ground voltage (V_{SSSPK}) [2]	0V
Flash Source Supply voltage (V_{CCFS}) [4] – to regulate V_{CCF}	+2.7V to +5.5V
Flash Source Supply voltage (V_{CCFS}) [4] – tied to V_{CCF}	+2.25V to +3.6V
Flash Supply voltage - (V_{CCF}) [4] – regulated from V_{CCFS}	+2.4V to +3.0V
Flash Supply voltage - (V_{CCF}) [4] – tied to V_{CCFS}	+2.25V to +3.6V

NOTES:

[1] V_{CCD} 2.7 ~ 5.5V; No restrictions with respect to V_{CCA} and V_{CCSPK}.

[2] $V_{SSD} = V_{SSA} = V_{SSSPK}$

[3] In Class-AB mode: V_{CCSPK} must equal V_{CCA}. Otherwise: $V_{CCSPK} \geq V_{CCA}$.

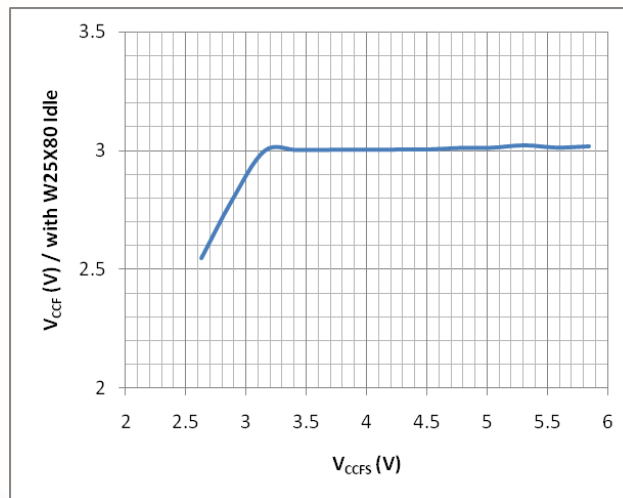[4] If V_{CCFS} is guaranteed to be below 3.6V (or upper flash supply limit), then V_{CCF} should be tied to V_{CCFS}.

Figure 6-1 V_{CCF} vs. V_{CCFS} – V_{CCF} is regulated internally from V_{CCFS}[4]

6.2 DC PARAMETERS

PARAMETER	SYMBOL	MIN	TYP [1]	MAX	UNITS	CONDITIONS
Digital Supply Voltage	V_{CCD}	2.7		5.5	V	
Analog Supply Voltage	V_{CCA}	2.7		5.5	V	
Speaker Supply Voltage	V_{CCSPK}	2.7		5.5	V	
Flash Source Supply Voltage	V_{CCFS}	2.7		5.5	V	to regulate V_{CCF}
		2.25		3.6		tied to V_{CCF}
Flash Supply Voltage (refer to Figure 6-1)	V_{CCF}		V_{CCFS} -0.3		V	regulated from V_{CCFS} V_{CCFS} = 2.7 ~ 3.3V
			3.0			regulated from V_{CCFS} V_{CCFS} = 3.3 ~ 5.5V
		2.25		3.6		tied to V_{CCFS}
Input Low Voltage	V_{IL}	V_{SSD}-0.3		0.3xV_{CCD}	V	
Input High Voltage	V_{IH}	0.7xV_{CCD}		V_{CCD}	V	
Output Low Voltage	V_{OL}	V_{SSD}-0.3		0.3xV_{CCD}	V	I_{OL} = 1mA
Output High Voltage	V_{OH}	0.7xV_{CCD}		V_{CCD}	V	I_{OH} = -1mA
INTB Output Low Voltage	V_{OH1}			0.4	V	
Playback Current	$I_{DD\_Playback}$			30	mA	
Standby Current	I_{SB}		1	10	µA	
Input Leakage Current	I_{IL}		±1		µA	Force V_{CCD}

Notes: [1] Conditions V_{CCD}=V_{CCA}=V_{CCSPK}=V_{CCFS}=3V, T_A=25°C unless otherwise stated

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6.3 AC PARAMETERS

6.3.1 Internal Oscillator

Parameter	Symbol	Min	Typ	Max	Units	CONDITIONS
Internal oscillator with internal reference	F_{INT}	-1%	2.048 MHz	+1%	MHz	V_{CCD} = 3.3V. At room temperature.
Internal oscillator with external reference	F_{EXT}	-2%	2.048 MHz	+2%	MHz	With ±1% precision resistor, 80kohm. V_{CCD} = 3.3V. At room temperature.

6.3.2 Inputs

AUX-IN:

Conditions: V_{CCD} = 3.3V, V_{CCA} = V_{CCSPK} = 5V, MCLK = 16.384MHz, T_A = +25°C, 1kHz signal

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
Auxiliary Analog Inputs (AUXIN)						
Full scale input signal [1]		Gain = 0dB		1.0 0		Vrms dBV
AUX Programmable gain			0		9	dB
AUX programmable gain step size		Guaranteed Monotonic		3		dB

Input resistance		Aux direct-to-out path, only
		  Input gain = +9.0dB
		  Input gain = +6.0dB
		  Input gain = +3.0dB
		  Input gain = 0dB
				21
				27
				33
				40
						kΩ
						kΩ
						kΩ
						kΩ

Aux-in Gain Accuracy	$A_{AUX(GA)}$		-0.5dB		+0.5dB	dB

Conditions: V_{CCD} = 3.3V, V_{CCA} = V_{CCSPK} = 3.3V, MCLK = 16.384MHz, T_A = +25°C, 1kHz signal

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
Auxiliary Analog Inputs (AUXIN)						
Full scale input signal [1]		Gain = 0dB		1.0 0		Vrms dBV
AUX Programmable gain			0		9	dB
AUX programmable gain step size		Guaranteed Monotonic		3		dB

Input resistance	Raux_in	Aux direct-to-out path, only
		  Input gain = +9.0dB
		  Input gain = +6.0dB
				21
				27
						kΩ
						kΩ

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
		Input gain = +3.0dB		33		kΩ
		Input gain = 0dB		40		kΩ
Aux-in Gain Accuracy	$A_{AUX(GA)}$		-0.5dB		+0.5dB	dB

6.3.3   Outputs

Aux-out

Conditions: V_{CCD} = 3.3V, V_{CCA} = V_{CCSPK} = 5V, MCLK = 16.384MHz, T_A = +25°C, 1kHz signal

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
Digital to Analog Converter (DAC) driving AUXOUT with 5kΩ / 100pF load						
Full-scale output		Gain paths all at 0dB gain		V_{CCA} / 3.3		V_{rms}
Signal-to-noise ratio	SNR	A-weighted		85		dB
Total harmonic distortion [2]	THD+N	R_L = 5kΩ; full-scale signal A-weighted		-80		dB

Conditions: V_{CCD} = 3.3V, V_{CCA} = V_{CCSPK} = 3.3V, MCLK = 16.384MHz, T_A = +25°C, 1kHz signal

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
Digital to Analog Converter (DAC) driving AUXOUT with 5kΩ / 100pF load						
Full-scale output		Gain paths all at 0dB gain		V_{CCA} / 3.3		V_{rms}
Signal-to-noise ratio	SNR	A-weighted		80		dB
Total harmonic distortion [2]	THD+N	R_L = 5kΩ; full-scale signal A-weighted		-77		dB

PWM OUTPUT

Conditions: V_{CCD} = 3.3V, V_{CCA} = V_{CCSPK} = 5V, MCLK = 16.384MHz, T_A = +25°C, 1kHz signal

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
Speaker PWM Output (SPK_PLUS / SPK_MINUS with 8Ω bridge-tied-load)						
Signal-to-noise ratio[3]	SNR	A-weighted + Class D Filter		65		dB
Total harmonic distortion [2]	THD	P_o = 1W, A-weighted + Class D Filter		-40		dB
Efficiency	E_{PWM}	8Ω bridge-tied-load Pout > 0.2W		85		%

Conditions: V_{CCD} = 3.3V, V_{CCA} = V_{CCSPK} = 3.3V, MCLK = 16.384MHz, T_A = +25°C, 1kHz signal

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
Speaker PWM Output (SPK_PLUS / SPK_MINUS with 8Ω bridge-tied-load)						
Signal-to-noise ratio[3]	SNR	A-weighted + Class D Filter		65		dB
Total harmonic distortion [2]	THD	A-weighted + Class D Filter		-40		dB
Efficiency	E_{PWM}	8Ω bridge-tied-load Pout > 0.2W		80		%

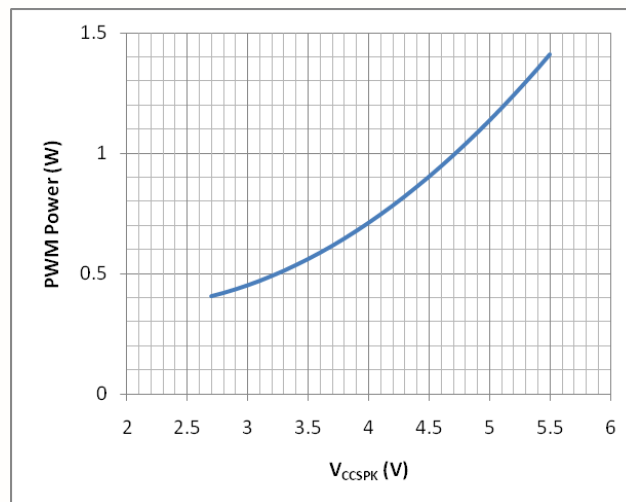
Figure 6-2 PWM Power vs. V_{CCSPK}

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CLASS-AB BTL OUTPUT

Conditions: V_{CCD} = 3.3V, V_{CCA} = V_{CCSPK} = 5V, MCLK = 16.384MHz, T_A = +25°C, 1kHz signal

Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
Speaker CLASS-AB BTL Output (SPK_PLUS / SPK_MINUS with 8Ω bridge-tied-load)						
Full scale output		Gain paths all at 0dB gain		V_{CCA} / 3.3		V_{rms}
Signal-to-noise ratio	SNR	A-weighted		90		dB
Total harmonic distortion [2]	THD	P_o = 1W, A-weighted		-60		dB
Efficiency	E_{AB}	8Ω bridge-tied-load Pout > 0.7W		50		%

Conditions: V_{CCD} = 3.3V, V_{CCA} = V_{CCSPK} = 3.3V, MCLK = 16.384MHz, T_A = +25°C, 1kHz signal

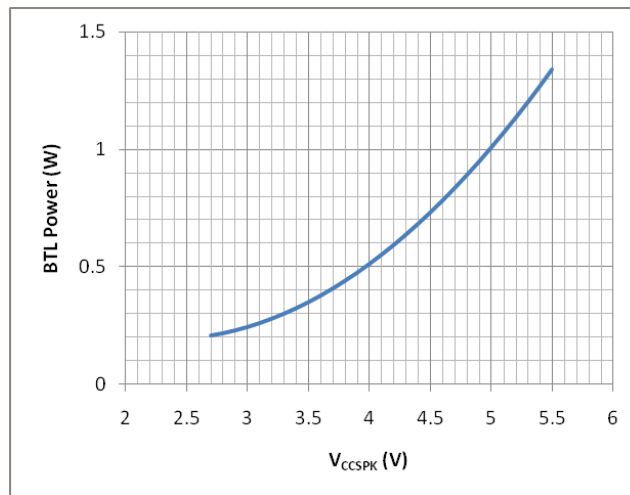| Parameter	Symbol	Comments/Conditions	Min	Typ	Max	Units
Speaker CLASS-AB BTL Output (SPK_PLUS / SPK_MINUS with 8Ω bridge-tied-load)						
Full scale output		Gain paths all at 0dB gain		V_{CCA} / 3.3		V_{rms}
Signal-to-noise ratio	SNR	A-weighted		84		dB
Total harmonic distortion [2]	THD	A-weighted		-60		dB
Efficiency	E_{AB}	8Ω bridge-tied-load Pout > 0.4W		50		%

Figure 6-3 Class-AB BTL Power vs. V_{CCSPK}

Notes
1. Full Scale is relative to the magnitude of VCCA and can be calculated as FS = VCCA/3.3.
2. Distortion is measured in the standard way as the combined quantity of distortion products plus noise. The signal level for distortion measurements is at 3dB below full scale, unless otherwise noted.
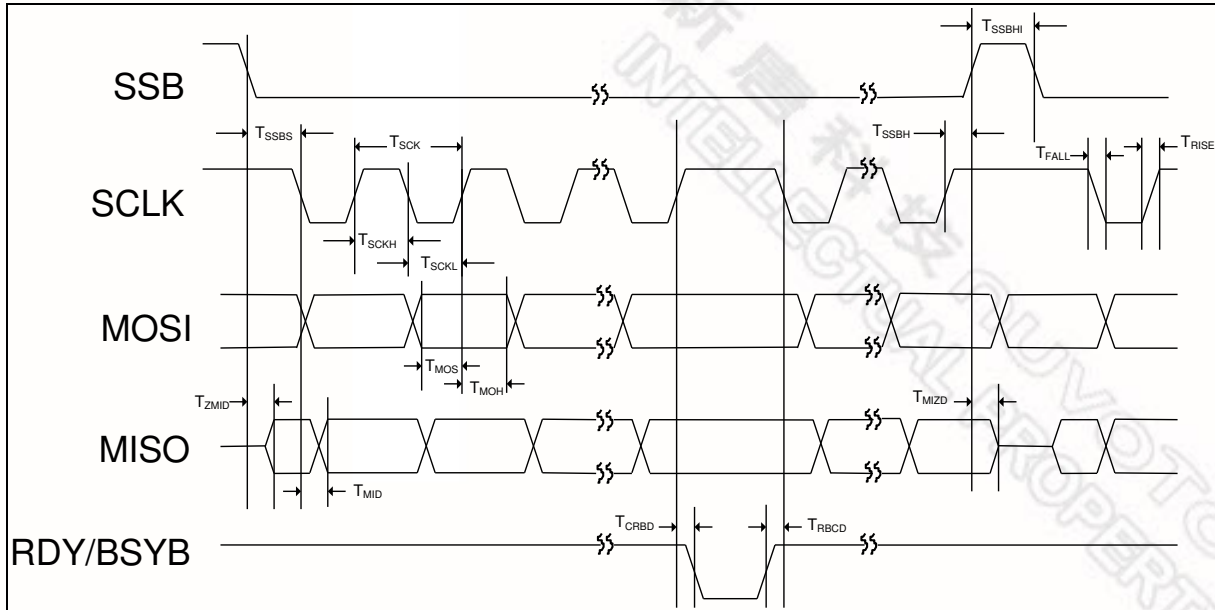3. SNR measured with a -100dbFS signal at input.

6.3.4 SPI Timing

Figure 6-4 SPI Timing

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNIT
T_{SCK}	SCLK Cycle Time	60	---	---	ns
T_{SCKH}	SCLK High Pulse Width	25	---	---	ns
T_{SCKL}	SCLK Low Pulse Width	25	---	---	ns
T_{RISE}	Rise Time for All Digital Signals	---	---	10	ns
T_{FALL}	Fall Time for All Digital Signals	---	---	10	ns
T_{SSBS}	SSB Falling Edge to 1st SCLK Falling Edge Setup Time	30	---	---	ns
T_{SSBH}	Last SCLK Rising Edge to SSB Rising Edge Hold Time	30ns	---	50us	---
T_{SSBHI}	SSB High Time between SSB Lows	20	---	---	ns
T_{MOS}	MOSI to SCLK Rising Edge Setup Time	15	---	---	ns
T_{MOH}	SCLK Rising Edge to MOSI Hold Time	15	---	---	ns
T_{ZMID}	Delay Time from SSB Falling Edge to MISO Active	--	--	12	ns
T_{MIZD}	Delay Time from SSB Rising Edge to MISO Tri-state	--	--	12	ns

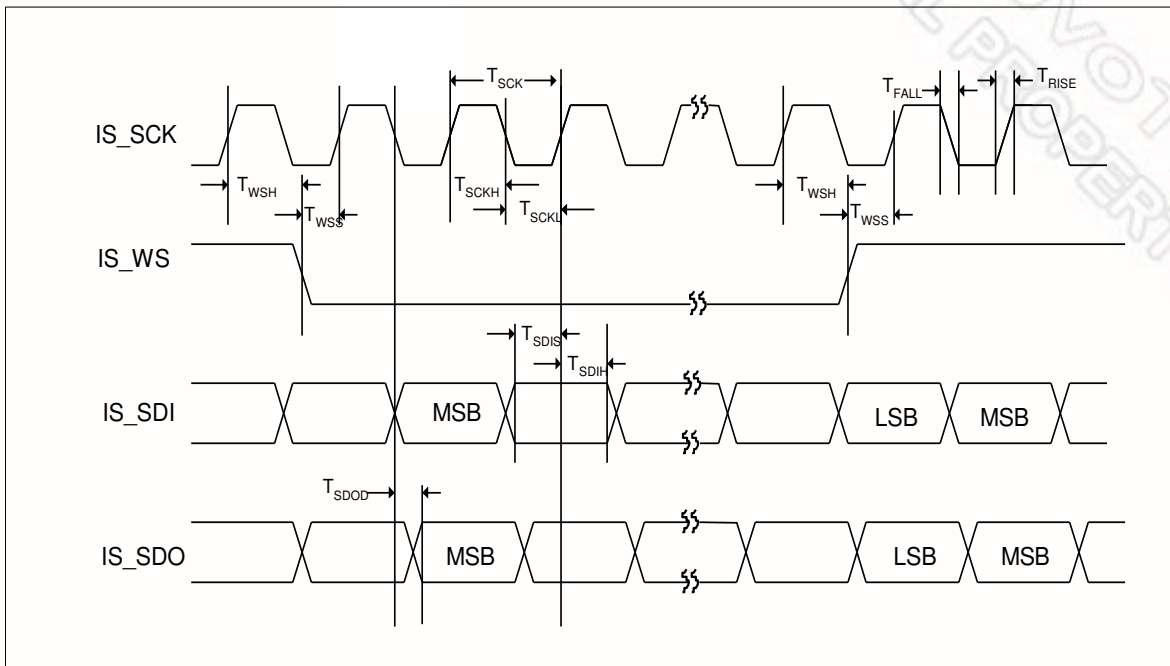| SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNIT
T_{MID}	Delay Time from SCLK Falling Edge to MISO	---	---	12	ns
T_{CRBD}	Delay Time from SCLK Rising Edge to RDY/BSYB Falling Edge	--	--	12	ns
T_{RBCD}	Delay Time from RDY/BSYB Rising Edge to SCLK Falling Edge	0	--	--	ns

6.3.5 I^2S Timing

Figure 6-5 I^2S Timing

SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNIT
T_{SCK}	IS_SCK Cycle Time	60	---	---	ns
T_{SCKH}	IS_SCK High Pulse Width	25	---	---	ns
T_{SCKL}	IS_SCK Low Pulse Width	25	---	---	ns
T_{RISE}	Rise Time for All Digital Signals	---	---	10	ns
T_{FALL}	Fall Time for All Digital Signals	---	---	10	ns

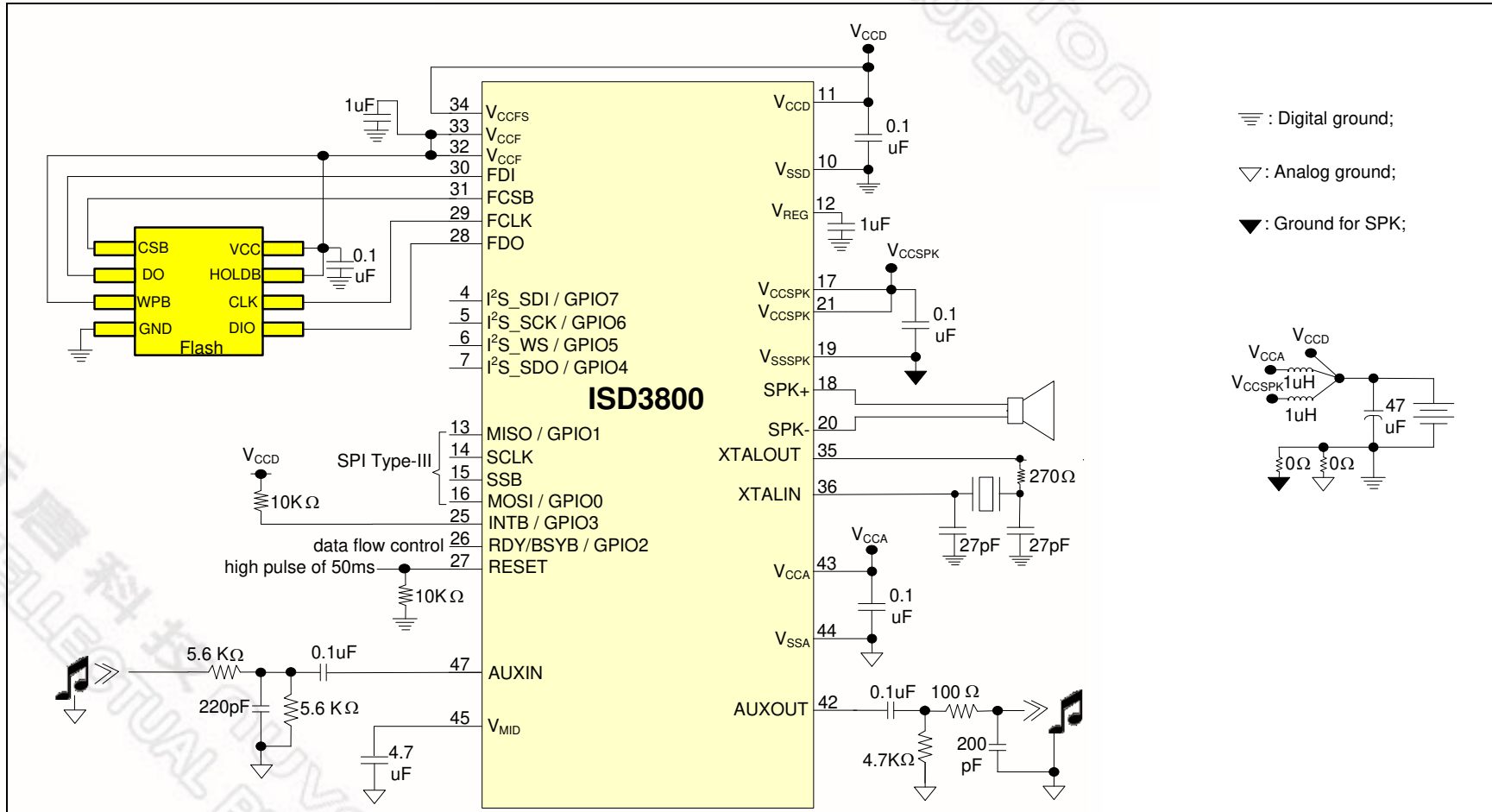| SYMBOL	DESCRIPTION	MIN	TYP	MAX	UNIT
T_{WSS}	WS to IS_SCK Rising Edge Setup Time	20	---	---	ns
T_{WSH}	IS_SCK Rising Edge to IS_WS Hold Time	20	---	---	ns
T_{SDIS}	IS_SDI to IS_SCK Rising Edge Setup Time	15	---	---	ns
T_{SDIH}	IS_SCK Rising Edge to IS_SDI Hold Time	15	---	---	ns
T_{SDOD}	Delay Time from IS_SCLK Falling Edge to IS_SDO	---	---	12	ns

7 APPLICATION DIAGRAM

Figure 7-1 ISD3800 Application Diagram – V_{CCF} is regulated internally from V_{CCFS}
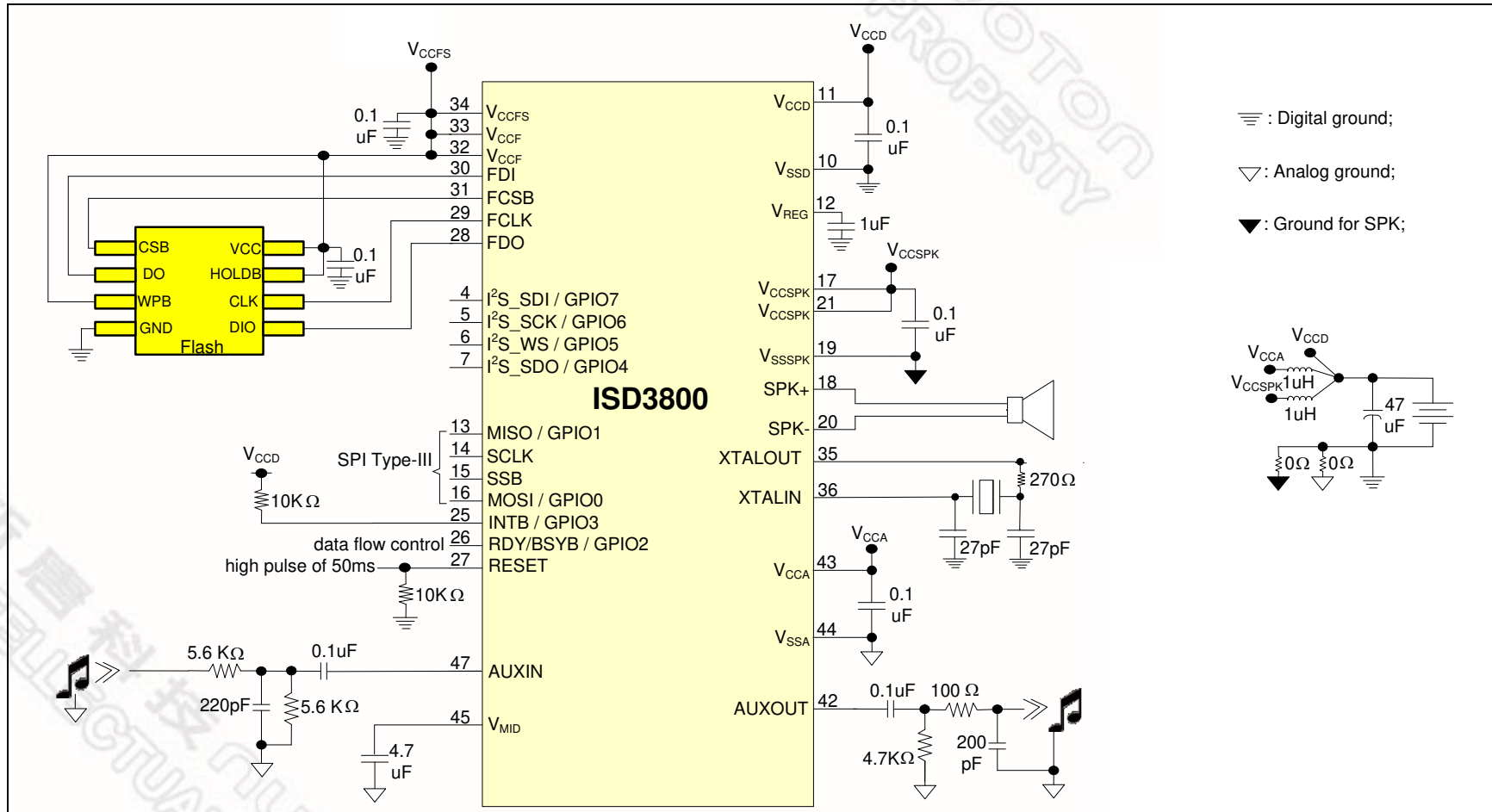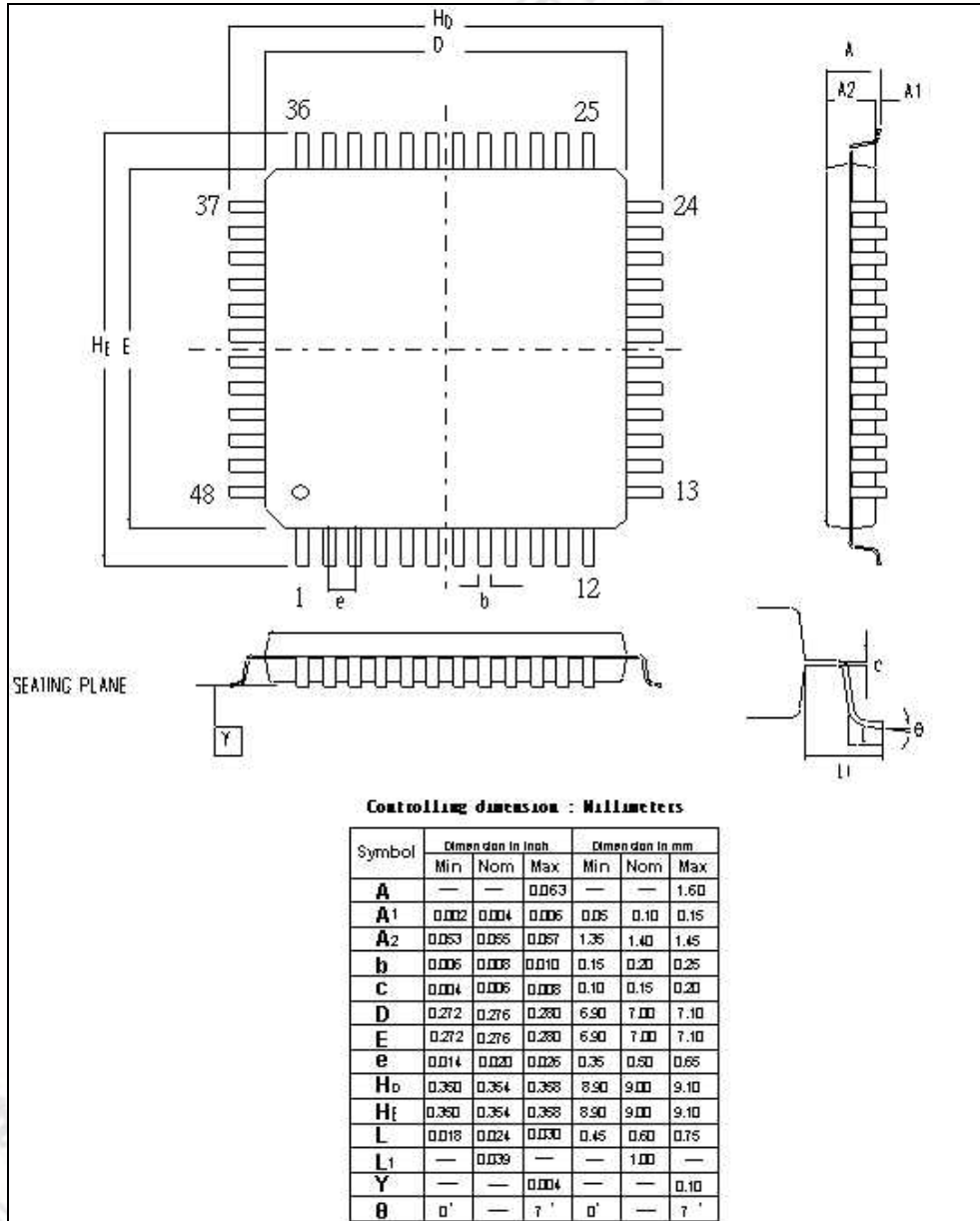
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Figure 7-2 ISD3800 Application Diagram – V$_{CCF}$ is tied to V$_{CCFS}$

The above application examples are for references only. It makes no representation or warranty that such applications shall be suitable for the use specified. Each design has to be optimized in its own system for the best performance on voice quality, current consumption, functionalities and etc.

8   PACKAGE SPECIFICATION

8.1   48 LEAD LQFP(7X7X1.4MM FOOTPRINT 2.0MM)

Controlling dimension : Millimeters

Symbol	Dimension in inch			Dimension in mm		
	Min	Nom	Max	Min	Nom	Max
A	—	—	0.063	—	—	1.60
A1	0.002	0.004	0.006	0.05	0.10	0.15
A2	0.053	0.055	0.057	1.35	1.40	1.45
b	0.006	0.008	0.010	0.15	0.20	0.25
c	0.004	0.006	0.008	0.10	0.15	0.20
D	0.272	0.276	0.280	6.90	7.00	7.10
E	0.272	0.276	0.280	6.90	7.00	7.10
e	0.014	0.020	0.026	0.35	0.50	0.65
HD	0.350	0.354	0.358	8.90	9.00	9.10
HE	0.350	0.354	0.358	8.90	9.00	9.10
L	0.018	0.024	0.030	0.45	0.60	0.75
L1	—	0.039	—	—	1.00	—
Y	—	—	0.004	—	—	0.10
θ	0°	—	7°	0°	—	7°

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9 ORDERING INFORMATION

I3800 <u>FYI</u>

> **Lead-Free Package Type**
> F: 48L-LQFP
> Y: Green (RoHS Compliant)
> I: Industrial -40 °C to 85°C

10 REVISION HISTORY

Version	Date	Description
0.23	Aug 3, 2009	Initially released as the Preliminary Datasheet.
0.26	Aug 17, 2009	Update application diagram.
0.27	Sep 28, 2009	Update the list of supported Flash Memory.
0.29	Nov 18, 2009	Update: • Block Diagram. • Electrical Characteristics.
0.35	Feb 8, 2010	Update block diagram.
0.40	July 1, 2010	Update crystal configuration.
0.50	Aug 12, 2010	Update PWM spec.
0.60	Sep 22, 2010	Update ordering information.
1.0	Aug 23, 2013	Add internal oscillator characteristics.